AII POWER DATA SHEET

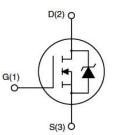
Feature

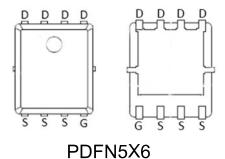
- 100V,85A
 R_{DS (ON)} <4. 6m Ω @V_{GS}=10V (TYP:3.8m Ω)
 R_{DS (ON)} <6. 4m Ω @V_{GS}=4.5V (TYP:5.2m Ω)
- Split Gate Trench Technology
- Lead free product is acquired
- Excellent R _{DS (ON)} and Low Gate Charge



PWM applications

- Load Switch
- Power management





Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity (PCS)
G046N01G	APG046N01G	PDFN5X6	-	-	5000

ABSOLUTE MAXIMUM RATINGS (T_a=25℃ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	100	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current (Ta =25°C)	lo	85	A
Continuous Drain Current (Ta =100°C)	ID	53	A
Pulsed Drain Currenr ⁽¹⁾	IDM	260	A
Single Pulsed Avalanche Energy ⁽²⁾	Eas	256	mJ
Power Dissipation	PD	56.8	W
Thermal Resistance from Junction to Case	Rejc	2.2	°C/W
Thermal Resistance from Junction to Ambient	Reja	50	°C/W
Junction Temperature	TJ	150	°C
Storage Temperature	T _{STG}	-55~ +150	°C

MOSFET ELECTRICAL CHARACTERISTICS(T₂=25℃ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Туре	Max	Unit
Static Characteristics				•		
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D =250µA	100	-	-	V
Zero gate voltage drain current	Dss	V _{DS} =100V, V _{GS} = 0V	-	-	1	μA
Gate-body leakage current	Igss	V_{GS} = ± 20 V, V_{DS} = 0V	-	-	±100	nA
Gate threshold voltage ⁽³⁾	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250µA	1.5	1.9	3.0	V
Drain-source on-resistance ⁽³⁾		V _{GS} =10V, I _D =30A	-	3.8	4.6	mΩ
	R _{DS(on)}	V _{GS} =4.5V, I _D =20A	-	5.2	6.4	mΩ
Gate Resistance	Rg	V _{DS} =V _{GS} =0V, f =1MHz	-	2.5	-	Ω
Dynamic characteristics						
Input Capacitance	Ciss		-	4590	-	pF
Output Capacitance	Coss	V _{DS} =50V, V _{GS} =0V, f =1MHz	-	1060	-	
Reverse Transfer Capacitance	Crss		-	38.4	-	
Switching characteristics				•		
Turn-on delay time	t _{d(on)}		-	20.4	-	ns
Turn-on rise time	tr	V _{DD} =50V, I _D =80A, V _{GS} =10V, R _G =6Ω	-	31	-	
Turn-off delay time	t _{d(off)}		-	76.8	-	
Turn-off fall time	tf		-	36.2	-	
Total Gate Charge	Qg	- VDS=50V, ID=40A, - VGS=10V	-	79	-	nC
Gate-Source Charge	Qgs		-	16	-	
Gate-Drain Charge	Qgd	- 003-100	-	16.4	-	
Reverse Recovery Chrage	Qrr	I _F =80A,di/dt=100A/us		52.7		nC
Reverse Recovery Time	Trr	I _F =80A,di/dt=100A/us		43.4		ns
Source-Drain Diode characteristics						
Diode Forward voltage ⁽³⁾	V _{DS}	V _{GS} =0V, I _S =40A	-	0.85	1.3	V
Diode Forward current ⁽⁴⁾	ls		-	-	85	А

Notes:

1. Repetitive Rating: pulse width limited by maximum junction temperature

2. EAS Condition:TJ=25 $^{\circ}$ C,VDD=50V,RG=25 $^{\Omega}$,L=0.5Mh,IAS=32A

3. Pulse Test: pulse width≤300µs, duty cycle≤2%

4. Surface Mounted on FR4 Board,t≤10 sec

Test circuits and waveforms



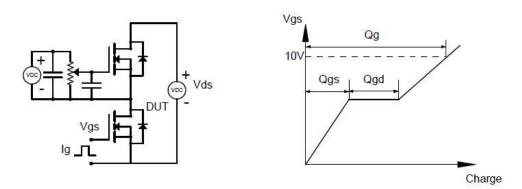


Figure B: Resistive Switching Test Circuit & Waveforms

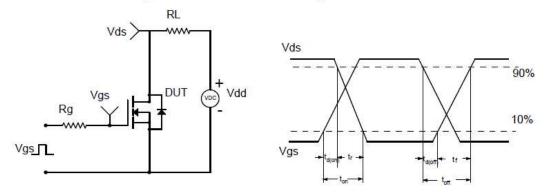


Figure C: Unclamped Inductive Switching (UIS) Test

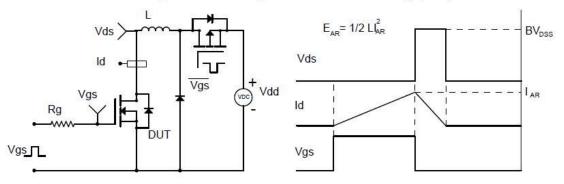
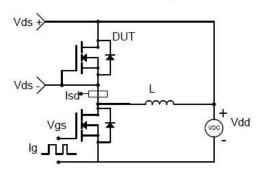
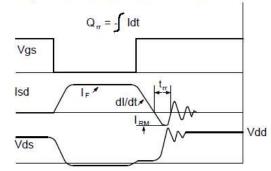


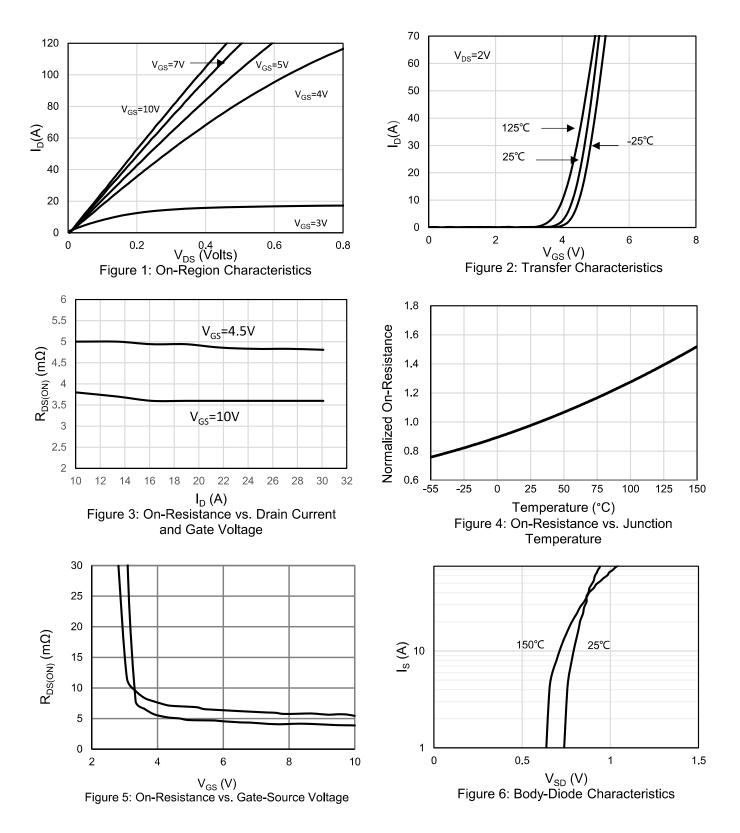
Figure D: Diode Recovery Test Circuit & Waveforms





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Typical Electronic and Thermal Characteristics



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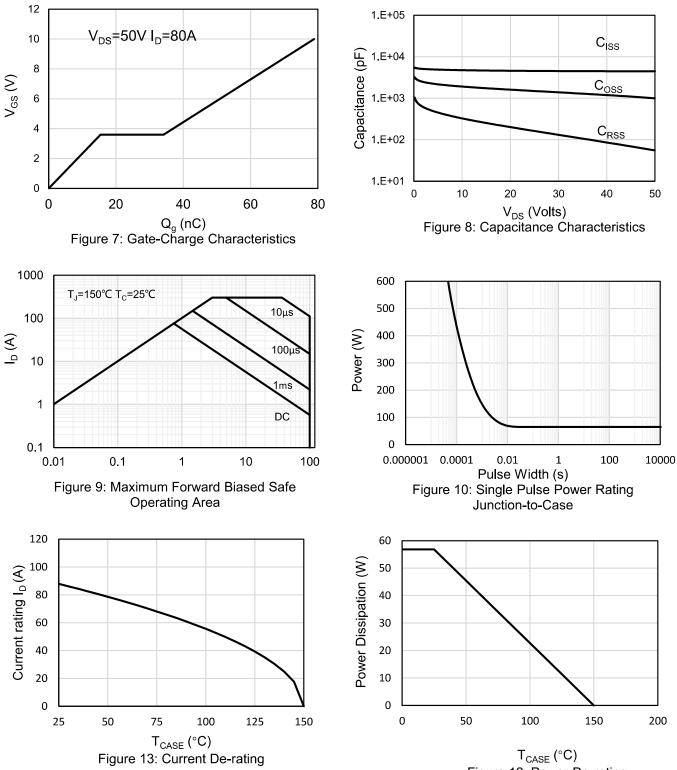
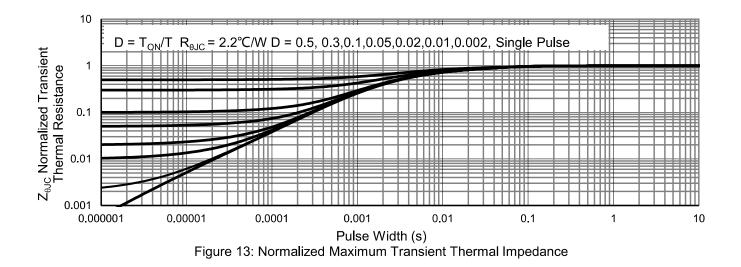
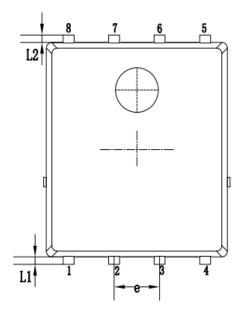


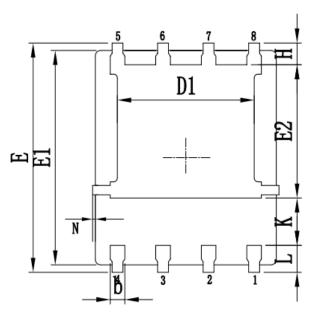
Figure 12: Power De-rating

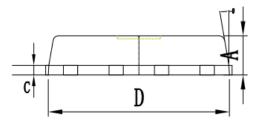


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PDFN5×6 Package Information







0.1.1	Willimeters			
Symbols	MIN.	NOM.	MAX.	
A	0.90	1 . 05	1.20	
b	0.20	0.40	0.50	
C	0.20	0.25	0.35	
D	4.80	5.05	5.20	
D1	3.80	3. 90	4. 10	
E	5.90	6.00	6.20	
E1	5.60	5.75	5.90	
E2	3.40	3. 50	3.60	
е	1.27 BSC.			
H	0.40	0.60	0. 70	
K	1.17	1.27	1.37	
L	0.50	0.74	0.84	
L1/L2	0.10	0.16	0. 20	
θ	8°	10°	12°	
N	0	-	0. 15	

Revision History

Revision	Release	Remark
V1.0	2024/03/13	Initial Release
V1.1	2024/08/10	Update POD

Disclaimer

The information given in this document describes the independent performance of the product,but similar performance is not guaranteed under other working conditions,and cannot be guaranteed when installed with other products or equipment. To achieve the required performance of the product in actual scenarios, the customer should conduct a complete application test to assess the functionality of the product.

Allpower assumes no responsibility for equipment failures result from using products at values that exceed the ratings, operating conditions, or other parameters listed in the product specifications.

The product described in this specification is not applicable for aerospace or other applications which requires high reliability.Customers using or selling these products for use in medical,life-saving,or life-sustaining applications do so at their own risk and agree to fully indemnify.

Due to product or technical improvements, the information described or contained herein may be changed without prior notice.